

Printed-circuit board connector - MC 1,5/12-G-3,81 P26 THRR72 - 1782569

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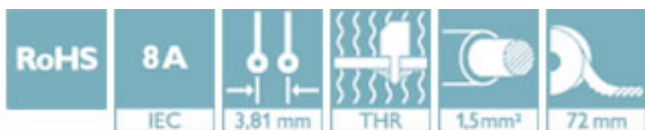
PCB headers, nominal current: 8 A, rated voltage (III/2): 160 V, nominal cross section: 1.5 mm², number of positions: 12, pitch: 3.81 mm, color: black, contact surface: Tin, mounting: THR soldering, pin layout: Linear pinning, solder pin [P]: 2.6 mm




The figure shows a 10-position version of the product

Your advantages

- Designed for integration into the SMT soldering process
- Maximum flexibility when it comes to device design – one header for connectors with different connection technologies



Key Commercial Data

Packing unit	380 pc
Minimum order quantity	380 pc
GTIN	 4 046356 550376
GTIN	4046356550376
Weight per Piece (excluding packing)	4.190 g
Custom tariff number	85366930
Country of origin	Germany
Note	Made to Order (non-returnable)

Technical data

Item properties

Brief article description	Feed-through header
Plug-in system	MINI COMBICON
Type of contact	Male connector
Range of articles	MC 1,5/...-G-THR
Pitch	3.81 mm
Number of positions	12
Mounting type	THR soldering

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Technical data

Item properties

Pin layout	Linear pinning
Locking	without
Number of levels	1
Number of connections	12
Number of potentials	12

Electrical parameters

Nominal current	8 A
Nom. voltage	160 V
Rated voltage	160 V
Rated voltage (III/2)	160 V
Rated voltage (II/2)	250 V
Rated surge voltage (III/3)	2.5 kV
Rated surge voltage (III/2)	2.5 kV
Rated surge voltage (II/2)	2.5 kV

Material data - contact

Note	WEEE/RoHS-compliant, free of whiskers according to IEC 60068-2-82/ JEDEC JESD 201
Contact material	Cu alloy
Surface characteristics	Tin-plated
Metal surface contact area (top layer)	Tin (3 - 5 µm Sn)
Metal surface contact area (middle layer)	Nickel (1 - 3 µm Ni),
Metal surface soldering area (top layer)	Tin (3 - 5 µm Sn)
Metal surface soldering area (middle layer)	Nickel (1.3 - 3 µm Ni)

Material data - housing

Housing color	black (9005)
Insulating material	LCP
Insulating material group	IIIa
CTI according to IEC 60112	175
Flammability rating according to UL 94	V0

Dimensions for the product

Caption	Schematic representation – for additional information, see product range drawing in the Download Center
Length [l]	9.2 mm
Width [w]	47.11 mm
Height [h]	9.5 mm
Pitch	3.81 mm
Height (without solder pin)	6.9 mm
Solder pin [P]	2.6 mm

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Technical data

Dimensions for the product

Pin dimensions	0.8 x 0.8 mm
Dimension a	41.91 mm

Dimensions for PCB design

Hole diameter	1.4 mm
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Packaging information

Type of packaging	72 mm wide tape
Pieces per package	380
Denomination packing units	Pcs.
[W] tape width	72 mm
[A] coil diameter	330 mm
[W2] coil overall dimension	78.4 mm
Outer packaging type	Transparent-Bag

General product information

Note	In accordance with IEC 61984, COMBICON connectors have no switching power (COC). During designated use, they must not be plugged in or disconnected when carrying voltage or under load.
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Processing notes

Process	Reflow/wave soldering
Specification	Following IPC/JEDEC J-STD-020D.1:2008-03
	Following IEC 61760-1:2006-04
	Following IEC 60068-2-58:2005-02
Moisture Sensitive Level	MSL 1
Classification temperature T _c	260 °C
Solder cycles in the reflow	3

Ambient conditions

Ambient temperature (storage/transport)	-40 °C ... 70 °C
Ambient temperature (assembly)	-5 °C ... 100 °C
Ambient temperature (operation)	-40 °C ... 100 °C (dependent on the derating curve)

Air clearances and creepage distances

Clearances and creepage distances	IEC 60664-1:2007-04
Specification	IEC 60664-1:2007-04
Minimum clearance - inhomogeneous field (III/3)	1.5 mm
Minimum clearance - inhomogeneous field (III/2)	1.5 mm
Minimum clearance - inhomogeneous field (II/2)	1.5 mm
Minimum creepage distance value (III/3)	2.5 mm
Minimum creepage distance value (III/2)	1.6 mm
Minimum creepage distance value (II/2)	3.2 mm

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Technical data

Mechanical tests (A)

Insertion strength per pos. approx.	8 N
Withdraw strength per pos. approx.	6 N
Polarization when inserted requirement >20 N	Test passed
Contact holder in insert requirements >20 N	Test passed

Durability tests (B)

Specification	IEC 60512-9-1:2010-03
Contact resistance R ₁	1.4 mΩ
Insertion/withdrawal cycles	25
Contact resistance R ₂	1.5 mΩ
Impulse withstand voltage at sea level	2.95 kV
Power-frequency withstand voltage	1.39 kV
Insulation resistance, neighboring positions	> 5 TΩ

Climatic tests (D)

Specification	ISO 6988:1985-02
Cold stress	-40 °C/2 h
Thermal stress	100 °C/168 h
Corrosive stress	0.2 dm ³ SO ₂ on 300 dm ³ /40 °C/1 cycle
Impulse withstand voltage at sea level	2.95 kV
Power-frequency withstand voltage	1.39 kV

Environmental and durability tests (E)

Specification	IEC 61984:2008-10
Result, degree of protection, IP code	Finger safety with IP20 test finger

Standards and Regulations

Connection in acc. with standard	EN-VDE
	CUL
Flammability rating according to UL 94	V0

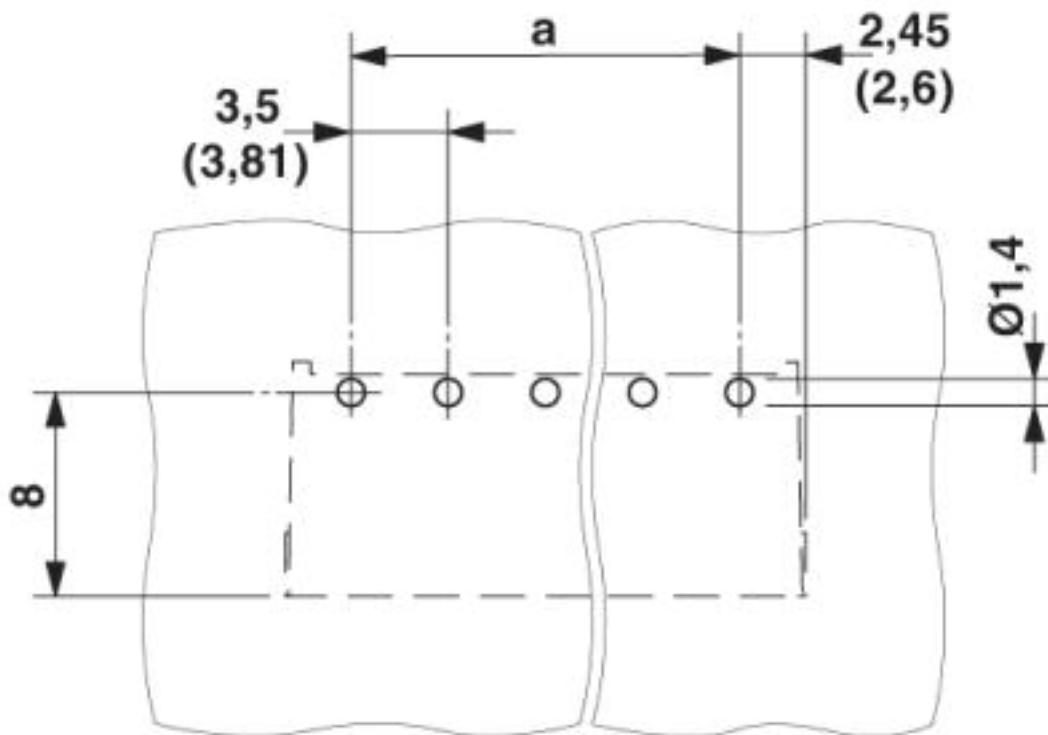
Environmental Product Compliance

China RoHS	Environmentally friendly use period: unlimited = EFUP-e
	No hazardous substances above threshold values

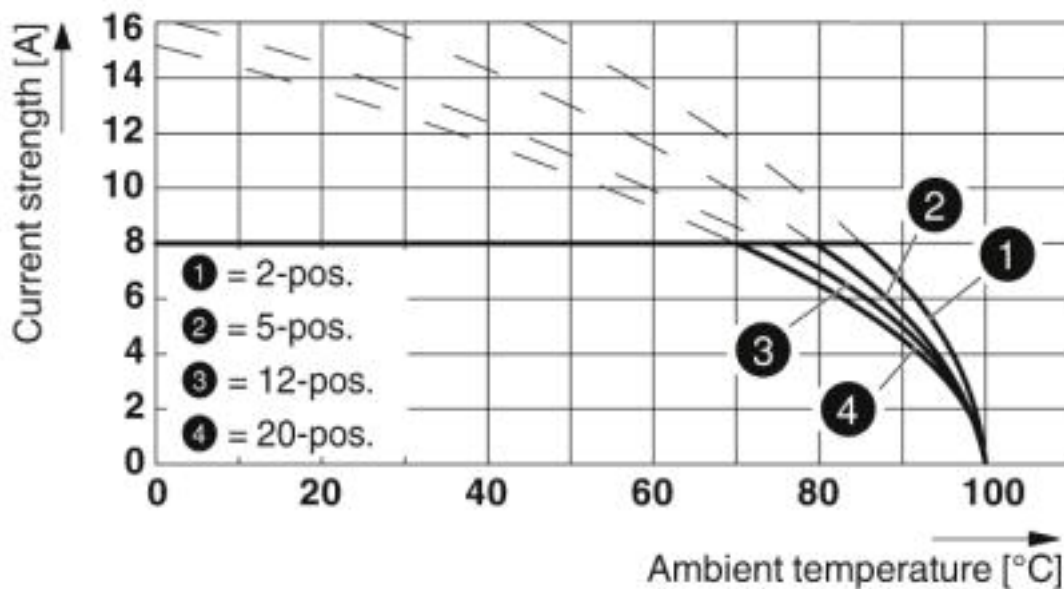
Drawings

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Drilling diagram



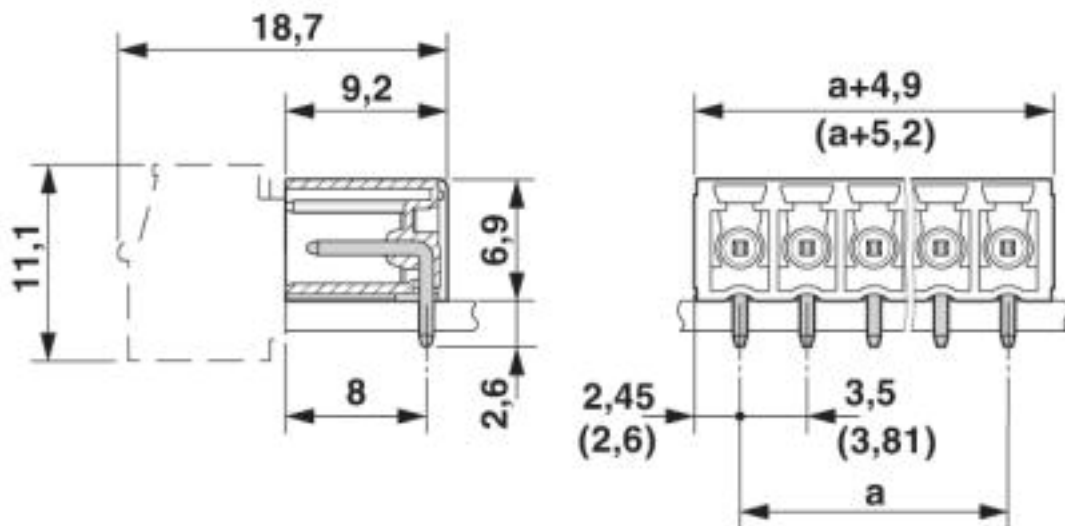
Diagram



Type: FK-MCP 1,5/...-ST-3,81 with MC 1,5/...-G-3,81 P... THR

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Dimensional drawing



Classifications

eCl@ss

eCl@ss 4.0	27260700
eCl@ss 4.1	27260700
eCl@ss 5.0	27260700
eCl@ss 5.1	27260700
eCl@ss 6.0	27260700
eCl@ss 7.0	27440402
eCl@ss 8.0	27440402
eCl@ss 9.0	27440402

ETIM

ETIM 4.0	EC002637
ETIM 5.0	EC002637
ETIM 6.0	EC002637
ETIM 7.0	EC002637

UNSPSC

UNSPSC 6.01	30211810
UNSPSC 7.0901	39121409
UNSPSC 11	39121409
UNSPSC 12.01	39121409
UNSPSC 13.2	39121409
UNSPSC 18.0	39121409
UNSPSC 19.0	39121409

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Classifications

UNSPSC

UNSPSC 20.0	39121409
UNSPSC 21.0	39121409

Approvals


Approvals


Approvals


IECEE CB Scheme / VDE Gutachten mit Fertigungsüberwachung / EAC / cULus Recognized


Ex Approvals

Approval details

IECEE CB Scheme		http://www.iecee.org/	DE1-60987-B1B2
Nominal voltage UN	160 V		
Nominal current IN	8 A		

VDE Gutachten mit Fertigungsüberwachung		http://www2.vde.com/de/Institut/Online-Service/VDE-gepruefteProdukte/Seiten/Online-Suche.aspx	40011723
Nominal voltage UN	160 V		
Nominal current IN	8 A		

EAC		B.01687
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cULus Recognized		http://database.ul.com/cgi-bin/XYV/template/LISEXT/1FRAME/index.htm	E60425-20110128
Nominal voltage UN	B 300 V	D 300 V	
Nominal current IN	8 A	8 A	

